## GOVERNMENT OF INDIA MINISTRY OF ELECTRONICS AND INFORMATION TECHNOLOGY

### LOK SABHA

#### **UNSTARRED QUESTION NO. 5413**

TO BE ANSWERED ON: 05.04.2023

#### SEMICONDUCTOR INCENTIVE PROGRAMME

#### 5413. SHRI MANICKAM TAGORE B.:

Will the Minister of ELECTRONICS AND INFORMATION TECHNOLOGY be pleased to state:

- (a) whether it is a fact that India and the U.S. have signed a Memorandum of Understandings (MOU) on setting up semiconductor units in the country;
- (b) if so, the details thereof;
- (c) whether it is also a fact that these MoUs will help the country to play a larger role in the electronics supply;
- (d) whether it is also true that both India and U.S. are implementing semiconductor incentive programmes; and
- (e) if so, the details thereof?

#### **ANSWER**

# MINISTER OF STATE FOR ELECTRONICS AND INFORMATION TECHNOLOGY (SHRI RAJEEV CHANDRASEKHAR)

- (a), (b) & (c): Yes, Sir. During the 5<sup>th</sup>India-USA Commercial Dialogue, a MOU between India and the USA to establish Semiconductor Supply Chain and Innovation Partnership under the framework of 5<sup>th</sup>India-USA Commercial Dialogue has been signed on 10.03.2023 in New Delhi under Rule 12 of the Government of India Rules, 1961. The MOU has been signed to enhance bilateral collaboration on opportunities to advance resilient semiconductor supply chains and leverage complementary strengths of the two countries.
- (d) and (e): Yes, Sir. Government is very focused on its important objective of building& catalysing the overall semiconductor ecosystem and ensure that, it in-turn catalyses India's rapidly expanding electronics manufacturing and innovation ecosystem. Government has approved the Semicon India programme with a total outlay of INR 76,000 crore for the development of semiconductor and display manufacturing ecosystem in the country.

US Congress has passed the Chips & Science Act of 2022, with a package of US \$280 billion for high-tech manufacturing including US \$39 billion to incentivize production of semiconductors in USA.

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